





15th November, 2019

To.

The Manager,

Department of Corporate Services,

Bombay Stock Exchange Ltd.,

P.J. Towers, 00Dalal Street,

Mumbai-400001

Scrip Code: 526263

To.

The General Manager,

National Stock Exchange India Ltd.,

Exchange Plaza, Bandra Kurla Complex,

Bandra East.

Mumbai-400051

Ref: MOLDTECH

Dear Sir,

Sub: Disclosure of Related Party Transactions for the half year ended on 30th September, 2019

In Compliance with Regulation 23(9) of SEBI (Listing Obligations and Disclosure Requirements) (Amendments) Regulations, 2018, please find attached the disclosure of Related Party Transactions, on consolidated basis, in accordance with applicable accounting standards.

This is for your information and records.

Thanking you.

For Mold-Tek Technologies Limited

Sakshi Garg

Hyderahad Company Secretary

DISCLOSURE OF RELATED PARTY TRANSACTIONS

In pursuance with Regulation 23(9) of SEBI (listing obligations and Disclosure Requirements) (Amendments) Regulations, 2018

Related party transactions

Names of related parties and nature of relationships:

Names of the related parties	Nature of relationship
i) Key Managerial Personnel (KMP):	
Mr. J.Lakshmana Rao	Chairman & Managing Director
Mrs. J.Sudharani	Whole Time Director
Mrs. Sakshi Garg	Company Secretary
Mr. N.Satya Kishore	Chief Financial Officer
ii) Non-whole-time Directors	
Mr. A.Subramanyam	Director
Mr. P.Venkateswara Rao	Director
Dr.K.Venkata Appa Rao	Independent Director
Dr. Surya Prakash Gulla	Independent Director
Mr. C.Vasant Kumar Roy	Independent Director
Mr. Dhanraj Tirumala Narasimha Rao Togaru	Independent Director
Mr. Ramakrishna Bonagiri	Independent Director
Mr. Bhujanga Rao Janumahanti	Director
iii) Relatives of key managerial personnel:	
Mr. PSN Vamsi Prasad	Chief Manager - Son-in-law of Chairman & Managing
	Director
iv) Relative of director:	
Mr. A. Durga Sundeep	Chief Manager - Son of Director
v) Enterprises in which key managerial personnel and/or their relatives have control:	
M/s. Mold-Tek Packaging Ltd	Group Company
vi) Subsidiary Company	
M/s. Mold-Tek Technologies Inc., USA	Wholly owned subsidiary



Details of transactions during the half year ended where related party relationship existed:

		1st April 2019 to
Names of the related parties	Nature of Transaction	30th Sept 2019
Mr. J.Lakshmana Rao	Remuneration	4433.55
Mrs. J.Sudharani	Remuneration	4461.92
Mr. J.Lakshmana Rao	Dividend paid	1107.21
Mrs. J.Sudharani	Dividend paid	1694.74
Mr. A.Subramanyam	Dividend paid	1412.07
Mr. P.Venkateswara Rao	Dividend paid	182.58
Dr.K.Venkata Appa Rao	Dividend paid	310.66
Dr. Surya Prakash Gulla	Dividend paid	3.92
Mr. Bhujanga Rao Janumahanti	Dividend paid	121.28
Mr. J. Rana Pratap	Dividend paid	703.20
Mr. PSN Vamsi Prasad	Dividend paid	40.00
Mr. A. Durga Sundeep	Dividend paid	475.95
M/s. Mold-Tek Packaging Ltd	Dividend paid	1693.73
Dr.K.Venkata Appa Rao	Sitting fees	15.00
Dr. Surya Prakash Gulla	Sitting fees	0.00
Mr. C.Vasant Kumar Roy	Sitting fees	0.00
Mr. Dhanraj Tirumala Narasimha Rao Togaru	Sitting fees	45.00
Mr. Ramakrishna Bonagiri	Sitting fees	45.00
Mr. Bhujanga Rao Janumahanti	Sitting fees	60.00
Mr. A. Durga Sundeep	Salary	1700.00
Mr. PSN Vamsi Prasad	Salary	1250.60
Mrs. Sakshi Garg	Salary	221.50
Mr. Satya Kishore N	Salary	765.00
M/s. Mold-Tek Technologies Inc., USA	Sales	304927.55
M/s. Mold-Tek Packaging Ltd	Sharing of Expenses	982.10
M/s. Mold-Tek Packaging Ltd	Other Income	740.01

Details of outstanding balances as at the half year end where related party relationship existed:

Names of the related parties	Nature of Balance	1st April 2019 to 30th Sept 2019
M/s. Mold-Tek Technologies Inc.	Trade Receivables	145917.08
M/s. Mold-Tek Packaging Limited	Advances Outstanding	3023.59

